AS0142AT-ADD/D

Product Preview

AS0142AT Advance Data Sheet Addendum

1/4–Inch Color CMOS Image Sensor and Signal Processor Stack Chip

Introduction

This document supplements ON Semiconductor's AS0142AT Advance Datasheet with reference information on:

- Ordering Information
- Package Pinout Overview
- Pinout Description
- AS0142AT Regulator Mode Connection

For further information on this 1/4–inch Color CMOS Image Sensor and Signal Processor Stack Chip housed within 143 balls iEBGA package, the Advance Datasheet should be referenced.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.



ON Semiconductor®

www.onsemi.com

ADDENDUM

1

REFERENCE INFORMATION

Table 1. ORDERING INFORMATION

Part Number	Product Description	Orderable Product Attribute Description
AS0142ATSC00XUSM0-DRBR-E	Rev1, Engineering Sample, iEBGA Package	Dry-pack without Protective Film; Double Side ARC Glass
AS0142ATSC00XUSM0-DPBR-E	Rev1, Engineering Sample, iEBGA Package	Dry-pack with Protective Film; Double Side ARC Glass
AS0142ATSC00XUSM0-TRBR-E	Rev1, Engineering Sample, iEBGA Package	Tape & Reel without Protective Film; Double Side ARC Glass
AS0142ATSC00XUSM0-TPBR-E	Rev1, Engineering Sample, iEBGA Package	Tape & Reel with Protective Film; Double Side ARC Glass
AS0142ATSC00XUSM0H3-GEVB	AS0142 Rev 1 iEBGA Sample housed in DEMO 3 Headboard	N/A

Table 2. PACKAGE PINOUT OVERVIEW

	1	2	3	4	5	6	7	8	9	10	11	12	
Α	VDD_ 1V8	VAA_ 2V8	VAA_ 2V8	VAA_ 2V8	LDO_ 1V2	LDO_ 1V2	DOUT1	EXT_ REG	DOUT0	DOUT2	VDD_ 1V2	VDD_ 1V2	Α
в	VDD_ 1V8	VDD_ 1V8	NC	REG_ 1V8	REG_ 1V8	LDO_ 1V2	XTAL	DOUT7	ENLDO	DOUT9	VDD_ 1V2	PD_1	В
С	1V8 PHY	NC	NO BALL	NC	REG_ 1V8	2V8_ PHY	DOUT4	EXTCLK	DOUT5	DOUT10	DOUT3	DOUT6	С
D	NC	NC	1V8_IO	DGND	DGND	DGND	DGND	DGND	DGND	DOUT11	DOUT8	1V8/2V8/ 3V3_IO	D
Е	PD_1	PD_1	1V8_IO	DGND	DGND	DGND	DGND	DGND	DGND	DOUT12	DOUT13	1V8/2V8/ 3V3_IO	Е
F	PU_1	RESE T_ BAR	SPI_CS_ BAR	DGND	DGND	DGND	DGND	DGND	DGND	DOUT14	DOUT15	1V8/2V8/ 3V3_IO	F
G	SCLK	PU_1	SPI_SCL K	DGND	DGND	DGND	DGND	DGND	DGND	DOUT16	DOUT17	RESERV ED	G
н	FLASH	PD_2	STANDB Y	DGND	DGND	DGND	DGND	DGND	DGND	DOUT20	AGND	AGND	Н
J	PD_2	GPIO_ 5	PD_1	DGND	DGND	DGND	DGND	DGND	DGND	DOUT18	AGND	AGND	J
к	PD_2	SDATA	SADDR	GPIO_2	GPIO_1	GPIO_4	DOUT19	FRAME_ SYNC	DOUT23	DOUT21	AGND	AGND	К
L	NC	GPIO_ 6	SPI_ SDO	SPI_ SDI	OTPM_ 2V8	PD_1	GPIO_3	FRAME_ VALID	PD_1	META_LINE _VALID		PD_1	L
м	NC	NC	NC	NC	NC	NC	NC	LINE_ VALID	DOUT22	PIXCLK	NC	PD_2	М
	1	2	3	4	5	6	7	8	9	10	11	12	

Table 3. PINOUT DESCRIPTION

Pinout Category	Pinout Name(s)	Pinout Direction	Correspondent Ball(s)	Ball(s) Total	Note(s)
Power	1V8/2V8/3V3_IO	Supply	D12, E12, F12	3	·Host Interface Supply, 1.8V/ 2.8V/ 3.3V capable
	1V8_IO	Supply	D3, E3	2	·Sensor Interface Supply, 1.8V nominal
	2V8_PHY	Supply	C6	1	·Host HiSPi Supply, 2.8V nominal
	1V8_PHY	Supply	C1	1	·Sensor HiSPi Supply, 1.8V nominal
	OTPM_2V8	Supply	L5	1	·Host OTPM Supply, 2.8V nominal
	VAA_2V8	Supply	A2, A3, A4	3	·Sensor Array Supply, 2.8V nominal
	REG_1V8	Supply	B4, B5, C5	3	·Host Regulator Supply, 1.8V nominal
	VDD_1V8	Supply	A1, B1, B2	3	·Sensor Digital Core Supply, 1.8V nomi- nal
	LDO_1V2	Supply	A5, A6, B6	3	·Host Regulator Output, 1.2V nominal ·Sense Line embedded
	VDD_1V2	Supply	A11, A12, B11	3	·Host Digital Core Supply, 1.2V nominal
	AGND	Supply – GND	H11, H12, J11, J12, K11, K12	6	·Analog related Stack Chip Ground
	DGND	Supply – GND	D4 to D9, E4 to E9, F4 to F9, G4 to G9, H4 to H9, J4 to J9	36	·Digital related Stack Chip Ground
Host Regulator	ENLDO	Input	B9	1	·Host Regulator enable (REG_1V8 do- main)
Control	EXT_REG	Input	A8	1	·External Supply enable (VDD_1V2 do- main)
Master Clock	EXTCLK	Input	C8	1	•This can either be a square-wave gen- erated from an oscillator (in which case the XTAL input must be left unconnect- ed), or direct connection to a crystal
	XTAL	Output	B7	1	·If EXTCLK is connected to one pin of a crystal, the other pin of the crystal is connected to XTAL pin; otherwise this signal must be left unconnected.
SPI Interface	SPI_CS_BAR	Output	F3	1	·Chip select out to SPI flash or EEP- ROM memory
	SPI_SCLK	Output	G3	1	·Clock output for interfacing to an exter- nal SPI flash or EEPROM memory
	SPI_SDI	Input	L4	1	Data in from SPI flash or EEPROM memory Pin with Internal Pull Up Resistor When no SPI device detected, the logic state of this pin decides whether AS0142AT should perform Auto-Config- ure O: Do not Auto-Configure; Two-wire interface will be used to configure the device (i.e. Host-Configure mode) 1: Auto-Configure
	SPI_SDO	Output	L3	1	 Data out to SPI flash or EEPROM memory

Table 3. PINOUT DESCRIPTION

Pinout Category	Pinout Name(s)	Pinout Direction	Correspondent Ball(s)	Ball(s) Total	Note(s)
Two Wired	SCLK	Input	G1	1	 Host two-wire serial clock Recommended 1.5 KOhm to 1V8/2V8/3V3_IO
	SDATA	I/O	К2	1	·Host two-wire serial data ·Recommended 1.5 KOhm to 1V8/2V8/3V3_IO
General Purpose I/O	GPIO[6:1]	I/O	L2, J2, K6, L7, K4, K5	6	·Configurable Host I/O interface
Inactive Control	RESET_BAR	Input	F2	1	 Hard Reset Control, Active Low No Hardware State Retention Pin with Internal Pull Up Resistor
	STANDBY	Input	H3	1	·Hard Standby Control, Active High ·Hardware State Retention possible
Two Wire Address Definition	SADDR	Input	КЗ	1	 Selects device address for the two-wire slave serial interface When connected to GND the device ID is 0x90 When wired to 1V8/2V8/3V3_IO, the device ID is 0xBA
Host Output	PIXCLK	Output	M10	1	·Host pixel clock output
	FRAME_VALID	Output	L8	1	·Host frame valid output (synchronous to PIXCLK)
	LINE_VALID	Output	M8	1	·Host line valid output (synchronous to PIXCLK)
	META_LINE_VAL ID	Output	L10	1	·Line valid signal to indicate when Meta- data is valid ·There is an option to allow META_LINE_VALID to be reflected in LINE_VALID
	DOUT[23:0]	Output	K9, M9, K10, H10, K7, J10, G11, G10, F11, F10, E11, E10, D10, C10, B10, D11, B8, C12, C9, C7, C11, A10, A7, A9	24	·Host pixel data output (synchronous to PIXCLK)
	FRAME_SYNC	Output	K8	1	 Pass through to TRIGGER_OUT This signal should be connected to GND if not used
	TRIGGER_OUT	Output	L11	1	·Host Trigger signal to embedded image sensor
	FLASH	Output	H1	1	·External Flash Light Control Output

AS0142AT-ADD/D

Table 3. PINOUT DESCRIPTION

Pinout Category	Pinout Name(s)	Pinout Direction	Correspondent Ball(s)	Ball(s) Total	Note(s)
Special Pins	NC	DO NOT CONNECT	B3, C2, C4, D1, D2, L1, M1 to M7, M11	14	·ON Internal Monitor Function Only
	Reserved	DO NOT CONNECT	G12	1	·ON Internal Debug Only
	PU_1	I/O	F1, G2	2	·Embedded Image Sensor Two-Wires Pins (for Stack Chip internal communi- cation) ·Recommended 1.5 KOhm to 1V8_IO
	PD_1	I/O	B12, E1, E2, J3, L6, L9, L12	7	·Must be at Logic Low for proper Stack Chip Operation ·Recommended 10 KOhm to GND
	PD_2	I/O	H2, J1, K1, M12	4	·Pull down to GND for proper Stack Chip Operation ·Recommended 1 KOhm to GND

Table 4. AS0142AT REGULATOR MODE CONNECTION

Pinout Name	Internal Regulator Connection	External Supply Connection
REG_1V8	1.8 V Nominal	Tied to 1V8/2V8/3V3_IO
ENLDO	Tied to REG_1V8	Tied to GND
EXT_REG	GND	Tied to 1V8/2V8/3V3_IO
LDO_1V2	1.2 V nominal (Output)	Floating (No Connection)
VDD_1V2	Tied with LDO_1V2	External 1.2 V Nominal Supply

AS0142AT-ADD/D

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconducts harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative